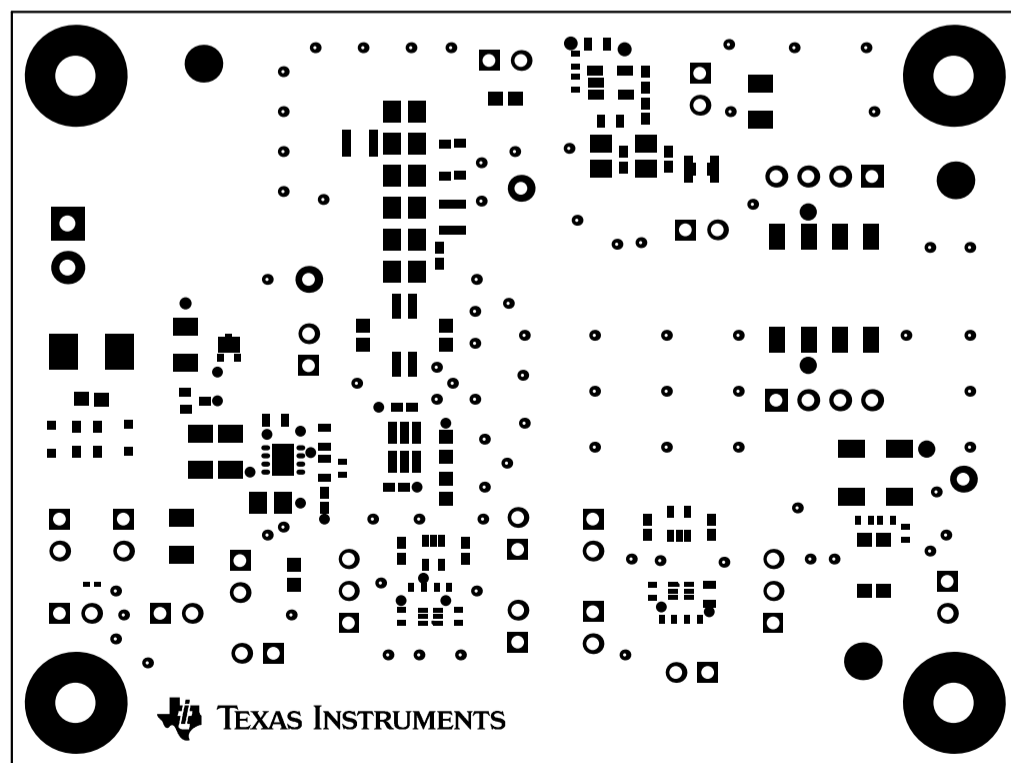
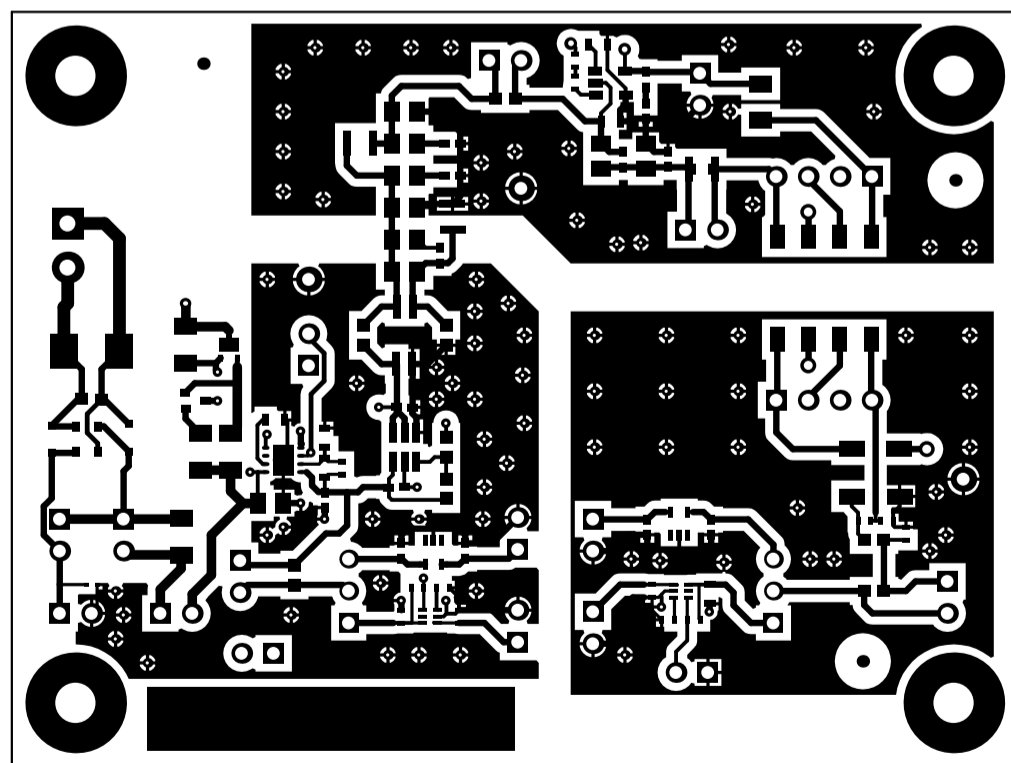


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 9/18/2014 5:23:35 PM	TEXAS INSTRUMENTS	

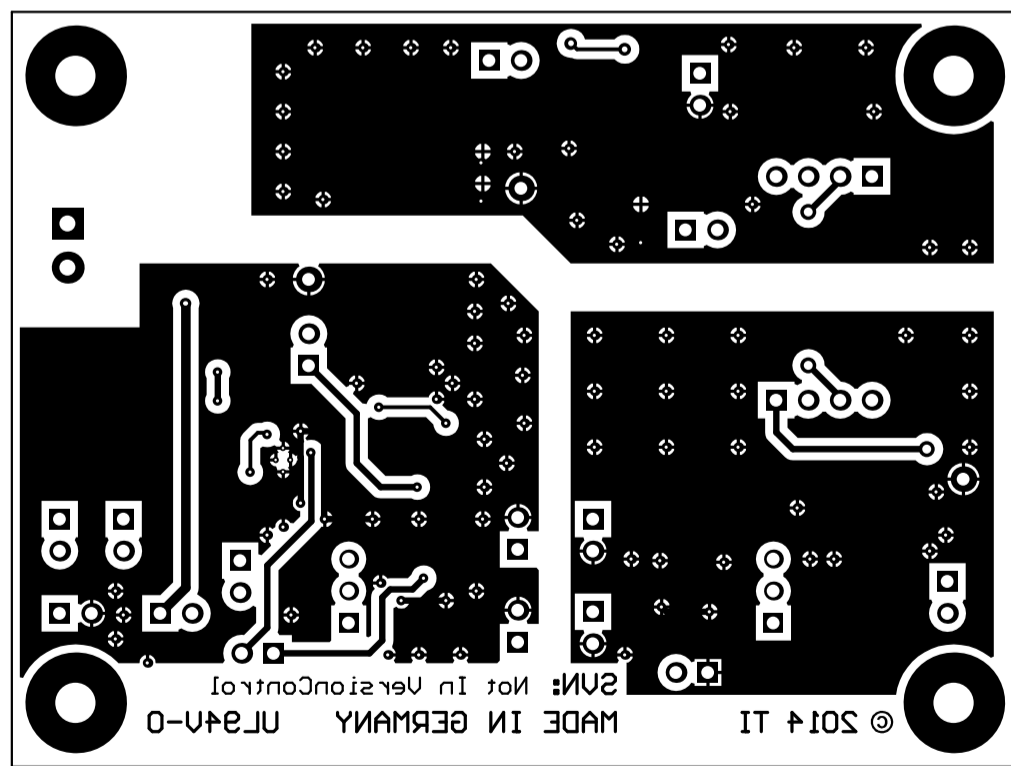
Layer Stack Up Detail for: TIDA-00167_IsolatedPower.PcbDoc			
Layer Name	Gerber Document	Copper Thickness	Dielectric Material
Top Solder Mask	<.GTS		Solder Resist
Top Layer	<.GTL	1.4mil	FR-4
Bottom Layer	<.GBL	1.4mil	
Bottom Solder Mask	<.GBS		Solder Resist



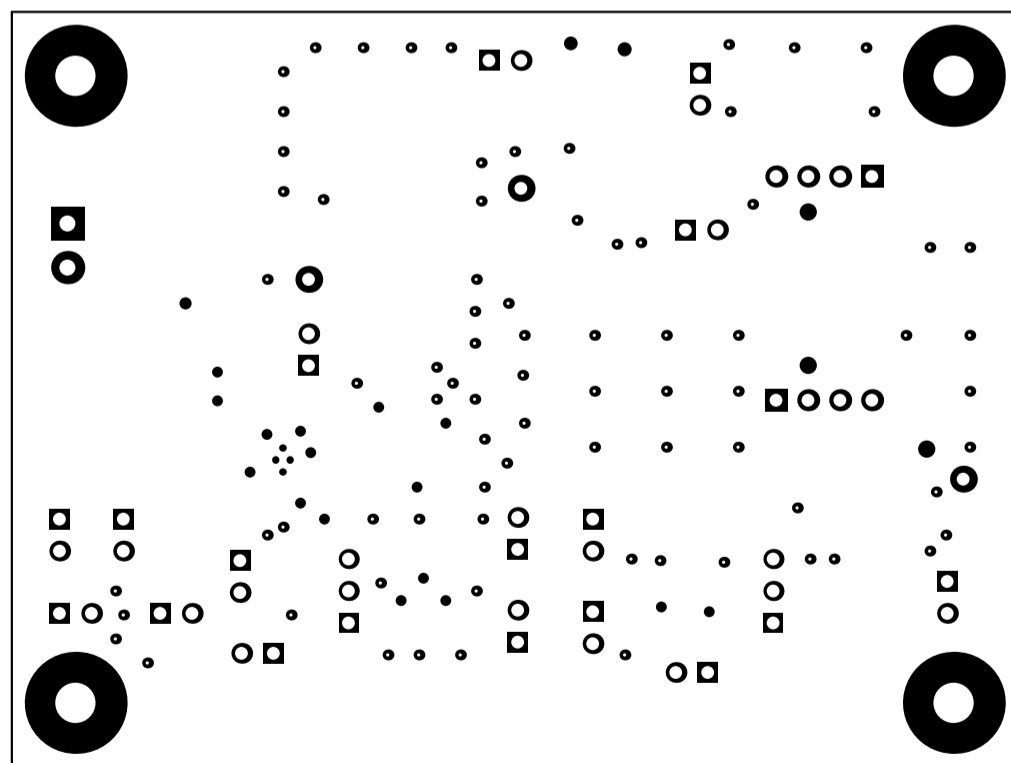
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 9/18/2014 5:23:35 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 9/18/2014 5:23:36 PM	TEXAS INSTRUMENTS	



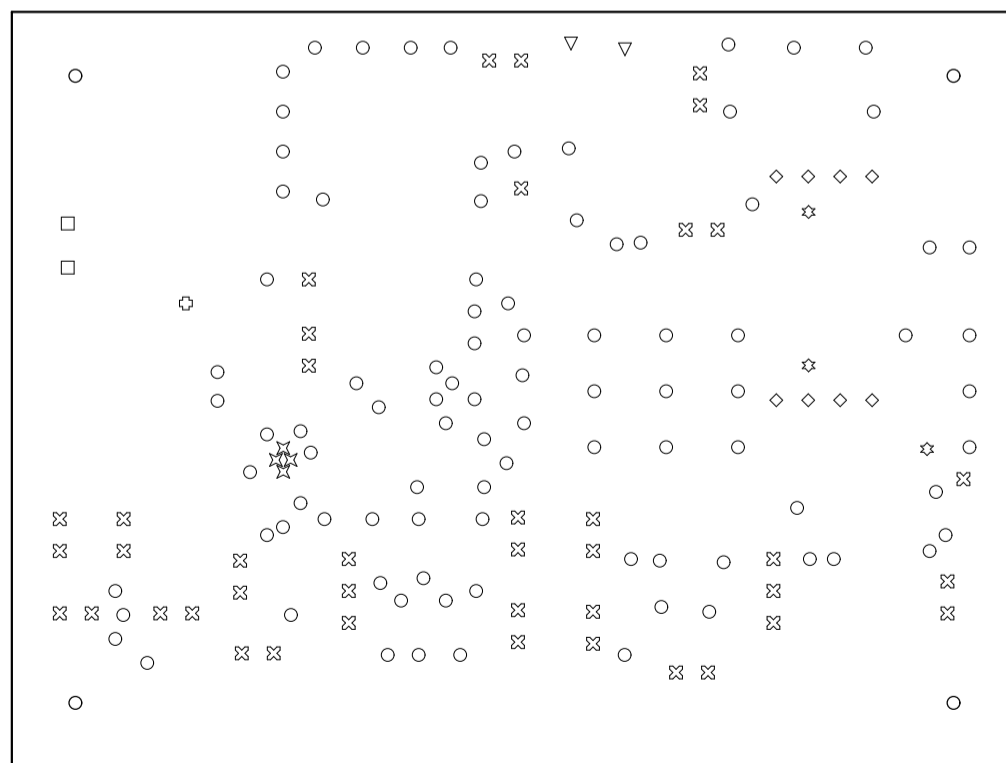
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 9/18/2014 5:23:36 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/18/2014 5:23:36 PM	TEXAS INSTRUMENTS	



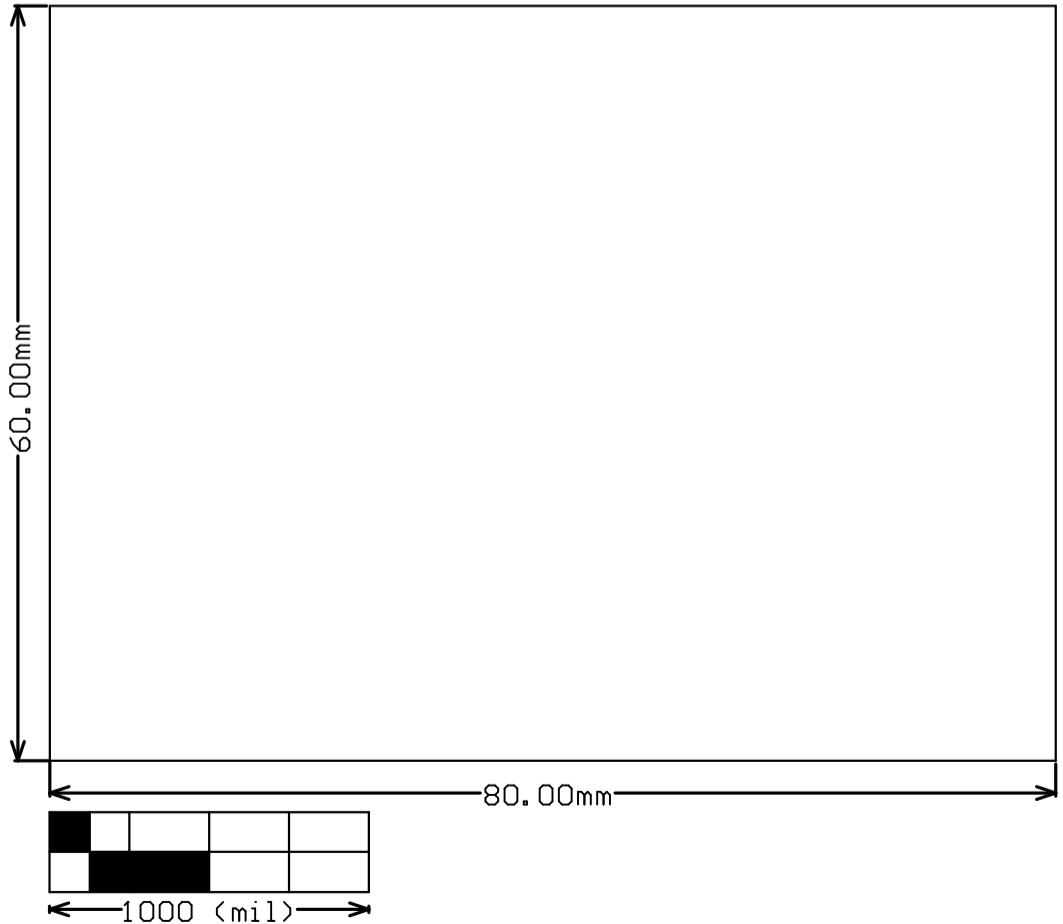
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 9/18/2014 5:23:37 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
⊗	4	7.874mil (0.2mm)	PTH	Round
○	94	10mil (0.254mm)	PTH	Round
⊕	1	15mil (0.381mm)	PTH	Round
▽	2	18mil (0.457mm)	PTH	Round
☆	3	28mil (0.711mm)	PTH	Round
◇	8	39.37mil (1mm)	PTH	Round
⊗	41	40mil (1.016mm)	PTH	Round
□	2	50mil (1.27mm)	PTH	Round
○	4	125.984mil (3.2mm)	PTH	Round
159 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 9/18/2014 5:23:37 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00167	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 9/18/2014 5:23:37 PM	TEXAS INSTRUMENTS	

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